Record of Letter Ballot Review by TC Chapter for Procedural Review

Region/Locale: North America

Global Technical Committee: 3D Packaging & Integration

TC Chapter Cochairs: Bill Kerr/Evergreen Enhancement, Chris Moore/Covalent Metrology

Standards Staff: Laura Nguyen

	Scheduled in Background Statement	Actual
Date	TBD	03/23/2021
Location	TBD	OVTCCM
Reason for Change of Date and/or Location (if changed)	COVID-19	

Note: See Regulations ¶ 9.5 Exceptions for allowable reason to change.

I. Document Number and Title

Document Number	Document Title
6591A	Revision to SEMI 3D20-0719, Specification for Panel
	Characteristics for Panel Level Packaging (PLP)
	Applications

II. Tally

Voting Tally: As-cast tally after close of voting period

Note: A minimum of 60% of the Voting Interests that have TC Members within the global technical committee that issued the Letter Ballot must return Votes. (*Regulations* ¶ 9.6.2.1.1)

Voting Tally (with example values):

Returned Votes		Distribution		Return Rate		
71 ÷		112	=	63.4%	≥60%	
55						
1		Total	Vote	rs with Rejects	1	
64						
	71 55	71 ÷ 55	71 ÷ 112 55 1 Total	71 ÷ 112 = 55 1 Total Vote:	71 ÷ 112 = 63.4% 55 1 Total Voters with Rejects	

Note: See *Regulations* § 3.2.1 for definition of Voting Interest.

III. Rejects

Voting Interest Reject 1 (Voting Interest Name: SEC) Voter Reject 1 (Voter: Tsukasa Fukunaga/Shin-Etsu Polymer)

Negative 1

-1159	vegative i							
	Referenced Section/	*TF/TC Chapter to fil	ll in, includi	ng text in the ballot	if necessary.			
Neg	Paragraph	Section 4.1						
Negative	Negative Text	copied.	*Original complete Negative text (e.g., issue, justification, suggestion) should be copied. In 4.1, isn't it necessary to add SEMI 3D12, which is referred in Table A1 1?					
		,	,					
TF	input (optional)							
	Withdrawal	X No Negative with	ndrawal mad	e by Voter.	GO TO "Related" subsection			
	(check one)	Withdrawal docu MM/DD/YYYY.	ment receive	ed by Standards staf	→ (A)			
	Motion and	X 'Related' is mutua	ally agreed ι	upon. <mark>(Needs no mo</mark>	tion.) GO TO "Persuasive" subsection			
	Reason	Negative is not re	elated. (Nee	ds ≥2/3 votes to pa	ss.)			
	(check one)	Reason	XXXX	(
Rel	Motion by/ 2 nd by	Name (Company)/Nam	Name (Company)/Name (Company)					
Related	Discussion							
	Result of Vote (check one)	XX Y-XX N; Motion pa	assed/failed					
		[Negative is not r	elated.] < 2/	GO TO "Persuasive" subsection				
		2/3 ≤ [Negative is	s not related	.]	GO TO "Final" subsection → (B)			
		Negative is relate	ed and persu	uasive. (Needs >1/3	votes to pass.)			
	Motion and Reason (check one)	X Negative is relate	ed and not p	ersuasive. (Needs ≥	2/3 votes to pass.)			
_	(oncor one)	Reason	The is	ssue can be resolved	d by an editorial change.			
Persuasive	Motion by/ 2 nd by	By: Cristina Chu / SEI Second: Gregory Arsl						
asiv	Discussion	None						
e e		7 Y-0 N; Motion pass	ed.					
	Result of Vote (check one)	[Negative is relat persuasive.] > 1/3	ed and	Is a technical change recommended?	Y GO TO "Address by Technical Change Option" subsection			
		[Negative is relat persuasive.] < 2/3		(check one)	N GO TO "Final" subsection → (E)			

		X	2/3 ≤ [Negative is related and not persuasive.] < 90%		GO TO "Final" subsection → (C)		
			90% ≤ [Negative is and not persuasiv		GO TO "Not Significant F	inding Option" subsection	
			(A)	Withdrawn	(counted under h in dispo	osition)	
			(B)	Not related (counted under i in disposition)		sition)	
	(check if	X	(C)	Related an	and not persuasive (significant)		
Final	applicable)		(D)	Not signific	cant (counted under j in dis	sposition)	
al					d persuasive and not by technical change	DOCUMENT FAILS	
			(F)	Addressed	Addressed by technical change (counted under k disposition)		
	(check if applicable) X Comment generated. See Section V-(ii) Comment # 1.						

This table is needed for each Negative.

Negative 2

-1159	Negative 2								
Z	Referenced Section/ Paragraph	*TF/TC Chapter to fill Table A2-1	in, including text in the ballot if nec	essary.					
Negative		*Original complete No	egative text (e.g., issue, justification	, suggestion) should be					
е	Negative Text	•	ble A2 1 has wrong figure numbers, e.g., GBIR is not shown in Figure A2						
TF	input (optional)								
	Withdrawal	X No Negative withd	drawal made by Voter.	GO TO "Related" subsection					
	(check one)	Withdrawal docum MM/DD/YYYY.	nent received by Standards staff on	GO TO "Final" subsection → (A)					
	Motion and	X 'Related' is mutually agreed upon. (Needs no motion		GO TO "Persuasive" subsection					
	Reason (check one)	Negative is not rel							
		Reason	xxxx						
Rel	Motion by/ 2 nd by	Name (Company)/Name (Company)							
Related	Discussion								
		XX Y-XX N; Motion pa	ssed/failed.						
	Result of Vote (check one)	[Negative is not re	elated.] < 2/3	GO TO "Persuasive" subsection					
	(6.100.101)	2/3 ≤ [Negative is	not related.]	GO TO "Final" subsection → (B)					
_		Negative is related	d and persuasive. (Needs >1/3 votes t	to pass.)					
Persuasive	Motion and Reason	X Negative is related	d and not persuasive. (Needs ≥2/3 vot	es to pass.)					
nsive	(check one)	Reason	The issue can be resolved by an	editorial change.					

	Motion by/ 2 nd by		r: Cristina Chu / SEMI Pathfinders econd: Mark Biedrzycki / ThermoFisher Scientific							
	Discussion	Non	lone							
	Result of Vote (check one)	7 Y-	0 N ; Motion passe	ed.						
			[Negative is relate persuasive.] > 1/3		Is a technical Y change recommended?		Y	GO TO "Address by Technical Change Option" subsection		
			[Negative is relate persuasive.] < 2/3		(check one)		N	GO TO "Final" subsection → (E)		
		X	2/3 ≤ [Negative is and not persuasiv		GO TO "Final" subsection → (C)					
			90% ≤ [Negative i and not persuasiv		GO TO "Not Significant Finding Option" subsection					
			(A)	Withdrawn	(counted under l	h in dis	spo	osition)		
			(B)	Not related	(counted under	i in dis	spc	sition)		
	(check if	X	(C)	Related and not persuasive (significant)			t)			
Fina	applicable)		(D)	Not signific	cant (counted und	ler j in	dis	sposition)		
a			(E)		d persuasive and by technical chan			DOCUMENT FAILS		
			(F)	Addressed	by technical chan	ge (co	un	ted under k disposition)		
	(check if applicable)	X	Comment genera	ted. See <mark>Se</mark>	ection V-(ii) Comn	nent #	<mark>2</mark> .			

Disposition of Voting Interest Reject 1

Check only when the Document has not been failed.

2	Original	Original number (#) of Negatives (g)				
0	Number	of N	egatives withdrawn		(h)	
0	Number	Number of Negatives found not related (i)				
0	Number of Negatives found not significant (j)					
0	Number become	(k)				
	Final		$\mathbf{g} - (\mathbf{h} + \mathbf{i} + \mathbf{j} + \mathbf{k}) = 0$	Reject is Not Valid and denominator of § VI. A	is not included in the pproval Conditions Check	
			g - (h + i +j + k) >0	Reject is included in the Approval Conditions	_	
			Reject without a Negative	Not Valid		

This table is needed for each Voting Interest Reject.

Note: If all of the Negatives included with a Reject Vote are withdrawn, determined to be not related, or determined to be not significant, the Reject Vote is not valid. (*Regulations* ¶ 9.4.3.3)

Note: A Negative addressed by a technical change is automatically considered to be not significant. (*Regulations* ¶ 9.6.1.4.5.2)

IV. Other Technical Issues None

V. Comments

V- (i) Voters' Comments

Commenter 1 (Lai-Cheng Kong/CMPUG Taiwan) - Comment 1

Com	*TF	*TF/TC Chapter to fill in section/paragraph #, if necessary.					
mment	Not very knowledgeable with PLP process, need to study more about PLP to be familiar.						
	The	The TC Chapter agreed to do one of the following actions.					
	*No motion is required in this step.						
A	Already addressed by Commenter #, Comment #						
Action	X	No further action was taken by the TC Chapter.					
		Refer to the TF for more consideration.					
		New Business					
		Editorial Change					

Commenter 2 (Hirokazu Tsunobuchi/Nidec-Sankyo) - Comment 1

Comment	The is restar	/TC Chapter to fill in section/paragraph #, if necessary. ere are several T7 descriptions. The scope of T7 is for silicon wafers. PLP Glass Carrier not a silicon wafer. When a new standard is developed, you should refer to that ndard. We are currently developing the following related standard. Document Number:					
		4 SNARF for: New Standard: Specification of ID Marking for Glass Carrier aracteristics of Panel Level Packaging (PLP) Applications					
	The TC Chapter agreed to do one of the following actions.						
	*No motion is required in this step.						
Þ	Already addressed by Commenter #, Comment #						
Action	X	No further action was taken by the TC Chapter.					
1	Refer to the TF for more consideration.						
		New Business					
		Editorial Change					

V-(ii) Comments Created by Handling Negative

Comment (Created by Handling Negative) NC - 1

(Voter: Tsukasa Fukunaga/Shin-Etsu Polymer)

12	*TF/TC Chapter to fill in					
mm	In 4.1, isn't it necessary to add SEMI 3D12, which is referred in Table A1 1?					

	The	e TC Chapter agreed to do one of the following actions.						
	*No	motion is	requ	uired in this step.				
Þ		Already addressed by Commenter #, Comment #						
Action		No further	actio	on was taken by the TC Chapter.				
		Refer to the TF for more consideration.						
		New business						
	X							
		Options		Case 1: No vote in this section:				
		for editorial		To be included and voted on as a group in § VI. Editorial Changes Other than Those Voted on in § V.				
		change		Case 2: Voted in this section:				
		(check one)	X	Original section number and at least one full sentence are required in "FROM" and "TO" fields.				
		FROM: S	ectio	on/Paragraph 4.1				
		4.1 <i>SEMI</i> .	Stana	lards and Safety Guidelines				
		SEMI G83	— S	pecification for Bar Code Marking of Product Packages				
		SEMI M1 — Specification for Polished Single Crystal Silicon Wafers						
		SEMI M12 — Specification for Serial Alphanumeric Marking of the Front Surface of Wafers						
		SEMI T7 — Specification for Back Surface Marking of Double-Side Polished Wafers with a Two- Dimensional Matrix Code Symbol						
Editorial Changes		TO: Section/Paragraph 4.1						
al CI	1	4.1 SEMI Standards and Safety Guidelines						
han		SEMI 3D1	2 —	Guide for Measuring Flatness and Shape of Low Stiffness Wafers				
ges		SEMI G83 — Specification for Bar Code Marking of Product Packages						
		SEMI M1 -	— Sp	ecification for Polished Single Crystal Silicon Wafers				
		SEMI M12	— S	pecification for Serial Alphanumeric Marking of the Front Surface of Wafers				
		SEMI T7 — Specification for Back Surface Marking of Double-Side Polished Wafers with a Two-Dimensional Matrix Code Symbol						
				(If necessary) nced standard.				
M	otion		Т	o approve above editorial change(s)				
M	otion	by/2 nd by		By: Cristina Chu / SEMI Pathfinders Second: Mark Biedrzycki / ThermoFisher Scientific				
Di	scus	sion	N	lone				
Vo	ote		7	Y-0 N; Motion passed.				

This table is needed for each Comment created by handling Negative.

Comment (Created by Handling Negative) NC – 2 (Voter: Tsukasa Fukunaga/Shin-Etsu Polymer)

<u>.cı.</u>	1 3 U	nasa Fuki	inaga/Shin-Etsu Polymer)							
Co	*TF/TC Chapter to fill in									
Comm		Table A2 1 has wrong figure numbers, e.g., GBIR is not shown in Figure A2 6 but in A2 4, etc.								
	The TC Chapter agreed to do one of the following actions.									
	*No	*No motion is required in this step.								
			dressed by Commenter #, Comment #							
Ac		-								
Action		No further action was taken by the TC Chapter.								
		Refer to the TF for more consideration.								
		New business								
	X	Editorial change								
			Case 1: No vote in this section:							
		Options	To be included and voted on as a group in § VI. E	ditorial Changes Other						
		for editorial	than Those Voted on in § V.	ditorial Chariges Other						
		change	Case 2: Voted in this section:							
		(check	X Original section number and at least one full se	ntence are required in						
		one)	"FROM" and "TO" fields.	ntonoo aro roquirou iii						
	FROM: Section/Paragraph Table A2-1									
		Table A1-1 Acronyms for Flatness Measurements								
		Acronym	Expanded Form of Acronym	Reference Figure						
		GBIR	Global Flatness, Back Surface, Ideal, Range	Figure A2-6						
		GF3R	Global Flatness, Front Surface, 3-point plane, Range	Not illustrated						
I_		GF3D	Global Flatness, Front Surface,3-point plane, Deviation	Not illustrated						
di		GFLR	Global Flatness, Front Surface, Least Squares fit, Range	Figure A2-7						
Ö		GFLD	Global Flatness, Front Surface, Least Squares fit, Deviation	Not illustrated						
ial	4	SBIR	Site Flatness, Back Surface, Ideal, Range	Figure A2-10						
오	1	SBID	Site Flatness, Back Surface, Ideal, Deviation	Figure A2-11						
lan		SF3R	Site Flatness, Front Surface, 3-point plane (global), Range	Not illustrated						
Editorial Changes		SF3D	Site Flatness, Front Surface, 3-point plane (global), Deviation	Not illustrated						
Š		SFLR	Site Flatness, Front Surface, Least Squares fit (global), Range	Not illustrated						
		SFLD	Site Flatness, Front Surface, Least Squares fit (global),	Not illustrated						
		SFQR	Site Flatness, Front Surface, Least Squares fit (site), Range	Figure A2-8						
		SFQD	Site Flatness, Front Surface, Least Squares fit (site), Deviation	Figure A2-9						
		SFSR	Site Flatness, Front Surface, Least Squares fit (subsite), Range ^{#1} Not illustrated							
		SFSD	Site Flatness, Front Surface, Least Squares fit (subsite), Deviation#2 Not illustrated							

Acronym	Expanded Form of Acronym	Reference Figur				
GBIR	Global Flatness, Back Surface, Ideal, Range	Figure A2-46				
GF3R	Global Flatness, Front Surface, 3-point plane, Range	Not illustrated Not illustrated				
GF3D	Global Flatness, Front Surface,3-point plane, Deviation					
GFLR	Global Flatness, Front Surface, Least Squares fit, Range	Figure A2- <u>5</u> 7				
GFLD	Global Flatness, Front Surface, Least Squares fit, Deviation	Not illustrated				
SBIR	Site Flatness, Back Surface, Ideal, Range	Figure A2-810				
SBID	Site Flatness, Back Surface, Ideal, Deviation	Figure A2- <u>9</u> 11				
SF3R	Site Flatness, Front Surface, 3-point plane (global), Range	Not illustrated				
SF3D	Site Flatness, Front Surface, 3-point plane (global), Deviation	Not illustrated				
SFLR	Site Flatness, Front Surface, Least Squares fit (global), Range	Not illustrated Not illustrated				
SFLD	Site Flatness, Front Surface, Least Squares fit (global),					
SFQR	Site Flatness, Front Surface, Least Squares fit (site), Range	Figure A2- <u>6</u> 8				
SFQD	Site Flatness, Front Surface, Least Squares fit (site), Deviation	Figure A2- <u>7</u> 9 Not illustrated				
SFSR	Site Flatness, Front Surface, Least Squares fit (subsite), Range#1					
SFSD	Site Flatness, Front Surface, Least Squares fit (subsite), Deviation#2 Not illustrated					
	Table are not numbered correctly. To approve above editorial change(s)					
7 11						
on by/2 nd by	By: Cristina Chu / SEMI Pathfinders Second: Gregory Arslanian / Air Products					
ussion	None					

VI. Editorial Changes Other than Those Voted on in § V None

VII. Approval Conditions Check VII. - (i). Approval Rate

APPROVAL CONDITION 1: All Negatives have been discussed and were withdrawn, found not related, found not persuasive, or addressed by a technical change. (*Regulations* ¶ 9.6.2.1.2)

APPROVAL CONDITION 2: At least 90% of the sum of valid Voting Interest Accept and Voting Interest Reject Votes must be Accept. (*Regulations* ¶ 9.6.2.1.3)

Note: If both approval conditions are not satisfied, the Document fails.

		Accepts		(Accepts + Valid Rejects)			
Approval Rate	=	64	/	65	=	98.5%	≥90%

VII. – (ii) Approval Level (check one)

Note: See *Regulations* § 9.6.2 for further information.



Globally Approved (No Ratification Ballot needed):

The Letter Ballot meets the Letter Ballot approval conditions for the global technical committee.



Need a Ratification Ballot:

The Letter Ballot meets the Letter Ballot approval conditions for the TC Chapter and a Ratification Ballot will be issued to validate technical changes.

VIII. Safety Check

Note: See *Regulations* § 15 for further information.

	X	Th is s	is is not a s	not a Safety Document , when all safety-related information is removed, the Document chnically sound and complete. (<i>Regulations</i> ¶ 8.7.1)							
Motion				is a Safety Document, when all safety-related information is removed, the Document is not nically sound and complete. (<i>Regulations</i> ¶ 8.7.2)							
		Safety Checklist (<i>Regulations</i> ¶ 15.3) is complete and has been included with the Documenthroughout the balloting process. (<i>Regulations</i> ¶ 15.1.2)									
ı	Moti	ion I	oy/2 nd by	By: Steve Martell / Nordson SONOSCAN Second: Cristina Chu / SEMI Pathfinders							
	D	iscu	ıssion	None							
		V	ote	8 Y-0 N; Motion passed							

IX. Intellectual Property (IP) Check

Note: This Letter Ballot may cover all or part of a Standard or Safety Guideline. Regardless of the coverage, this IP check applies to the entire Standard or Safety Guideline*. See *Regulations* § 16 for further information.

x	The TC Chapter meeting chair asked those participating, if they were aware of any patented technology that might be relevant (see <i>Regulations</i> ¶ 16.3.1.1) to the Standard or Safety Guideline; or, any copyrighted items or trademarks that are used/reproduced (see <i>Regulations</i> ¶ 16.4.1.2) in the Standard or Safety Guideline. (Also see, <i>Regulations</i> § 8.8)						
	х	The question is NOT answered in affirmative (No potentially material patented technology or use/reproduction of copyrighted items/trademarks is known.)	GO TO SECTION X.				
		The question is answered in affirmative	Is any of the known IPs a patented		Yes, at least one of them is a patented technology	GO TO IX (a) "Patented Technology" subsection	
			technology?		No	GO TO IX (b) "Copyright items" subsection	

X. Action for This Document

		This Document passed TC Chapter review as balloted and will be forwarded to the ISC A SC for procedural review.								
M	X		Document passed TC Chapter review with editorial changes and will be forwarded to the A&R SC for procedural review.							
Motion		editorial ch	cument passed TC Chapter review with technical changes and with or without changes and will be forwarded to the ISC A&R SC for procedural review. A on Ballot will be issued to verify the technical changes.							
		This Docur	ment failed TC Chapter review and will be returned to the TF for rework.							
		This Docur	his Document failed TC Chapter review and work will be discontinued.							
	Motion by/ 2 nd by		By: Steve Martell / Nordson SONOSCAN Second: Mark Biedrzycki / ThermoFisher Scientific							
[Discussion		None							
Vote		ote	8 Y-0 N							
F	inal	Action	X Motion passed							
	i iliai Action		Motion failed							

Note: If the use of PMPT or copyrighted item is justified by the TC Chapter, LOA or release form must be received before publication can proceed.